

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Young-Hee JUNG) Confirmation No.: 9496
Application No.: 10/682,081) Group Art Unit: 2815
Filed: October 10, 2003) Examiner: S. Clark
For: HIGH-DENSITY CHIP SCALE PACKAGE AND METHOD OF MANUFACTURING THE SAME)))

Commissioner for Patents
U.S. Patent and Trademark Office
2011 South Clark Place
Customer Window, Mail Stop Amendment
Crystal Plaza Two, Lobby, Room 1B03
Arlington, VA 22202

Sir:

AMENDMENT

In response to the Office Action dated September 22, 2004, the period for response to which extends through December 22, 2004, please amend the above-identified application as follows: